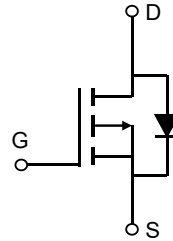


### Description

#### Features

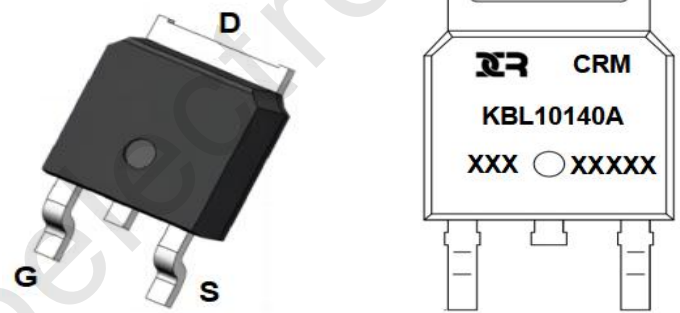
- -100V, -10A  
 $R_{DS(ON)}$  Typ = 150mΩ @  $V_{GS} = -10V$   
 $R_{DS(ON)}$  Typ = 170mΩ @  $V_{GS} = -4.5V$
- Advanced Trench Technology
- Excellent  $R_{DS(ON)}$  and Low Gate Charge
- 100% UIS TESTED!
- 100%  $\Delta V_d$ s TESTED!



Schematic Diagram

#### Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

#### Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKBL10140A	CRMKBL10140A	TO-252-3L	TAPING	13"	2500	25000

#### Absolute Maximum Ratings (@ $T_J = 25^\circ C$ unless otherwise specified)

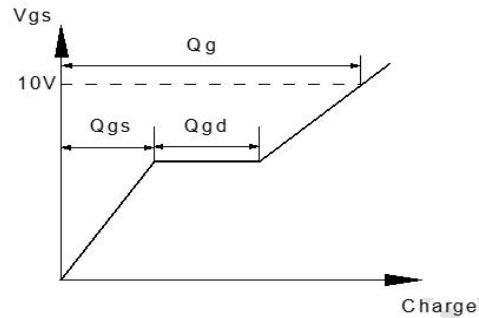
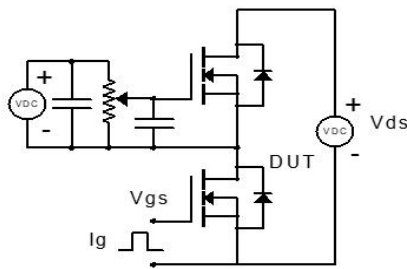
Symbol	Parameter	Value	Units	
$V_{DS}$	Drain-to-Source Voltage	-100	V	
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V	
$I_D$	Continuous Drain Current	$T_C = 25^\circ C$	-10	A
		$T_C = 100^\circ C$	-6	A
$I_{DM}$	Pulsed Drain Current <sup>(1)</sup>	-40	A	
$E_{AS}$	Single Pulsed Avalanche Energy <sup>(2)</sup>	46	mJ	
$P_D$	Power Dissipation	$T_C = 25^\circ C$	34	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.7	$^\circ C/W$	
$T_J, T_{STG}$	Junction & Storage Temperature Range	-55 to 150	$^\circ C$	

### Electrical Characteristics ( $T_J = 25^\circ\text{C}$ unless otherwise specified)

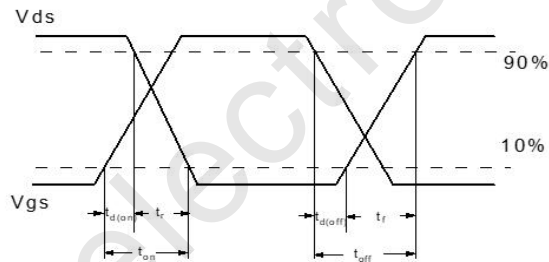
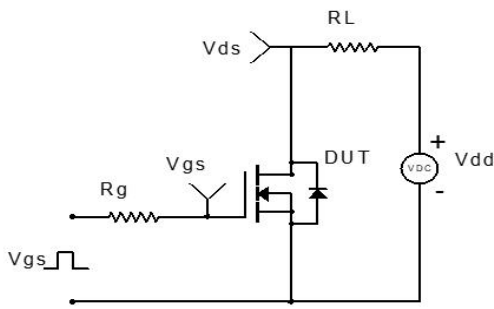
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = -250\mu\text{A}, V_{GS} = 0\text{V}$	-100	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = -100\text{V}, V_{GS} = 0\text{V}$	-	-	-1.0	$\mu\text{A}$
$I_{GSS}$	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-1.1	-1.6	-2.2	V
$R_{DS(ON)}$	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = -10\text{V}, I_D = -5\text{A}$	-	150	195	mΩ
		$V_{GS} = -4.5\text{V}, I_D = -4\text{A}$	-	170	221	mΩ
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance		-	2577	-	pF
$C_{oss}$	Output Capacitance	$V_{GS} = 0\text{V}, V_{DS} = -25\text{V},$ $f = 1\text{MHz}$	-	66	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	52	-	pF
$Q_g$	Total Gate Charge		-	45	-	nC
$Q_{gs}$	Gate Source Charge	$V_{GS} = 0 \text{ to } -10\text{V}$	-	4.5	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	$V_{DS} = -50\text{V}, I_D = -10\text{A}$	-	5.7	-	nC
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On DelayTime		-	22	-	ns
$t_r$	Turn-On Rise Time	$V_{GS} = -10\text{V}, V_{DD} = -50\text{V}$	-	30	-	ns
$t_{d(off)}$	Turn-Off DelayTime	$I_D = -6.5\text{A}, R_{GEN} = 10\Omega$	-	58	-	ns
$t_f$	Turn-Off Fall Time		-	48	-	ns
<b>Drain-Source Diode Characteristics and Max Ratings</b>						
$I_S$	Maximum Continuous Drain to Source Diode Forward Current		-	-	-10	A
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-40	A
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}, I_S = -5\text{A}$	-	-	-1.2	V

- Notes:
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
  2.  $E_{AS}$  condition: Starting  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = -50\text{V}$ ,  $V_G = -10\text{V}$ ,  $R_G = 25\text{ohm}$ ,  $L = 0.5\text{mH}$ ,  $I_{AS} = -13.5\text{A}$
  3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .

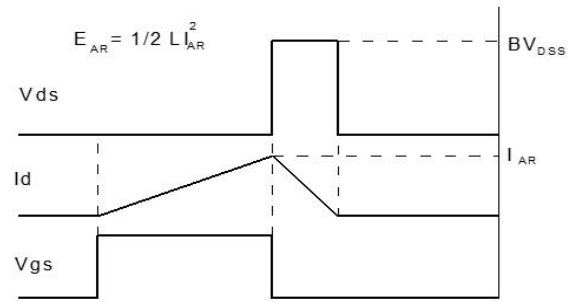
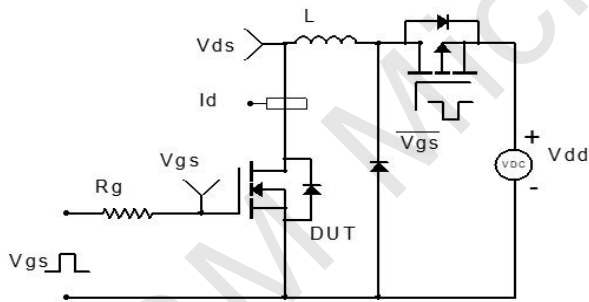
**Test Circuit**



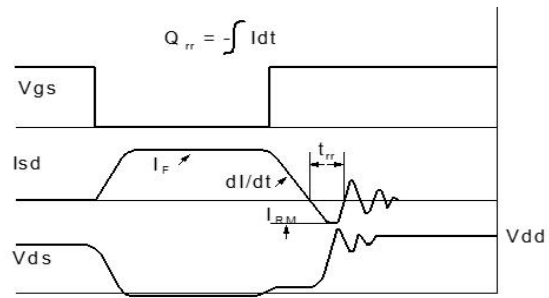
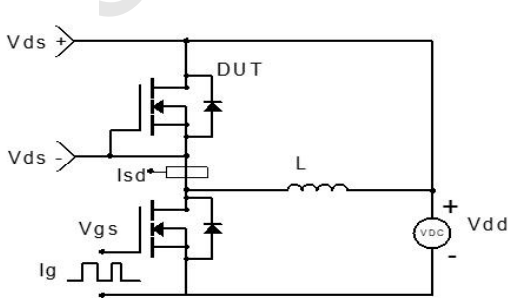
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**

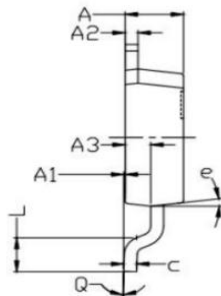
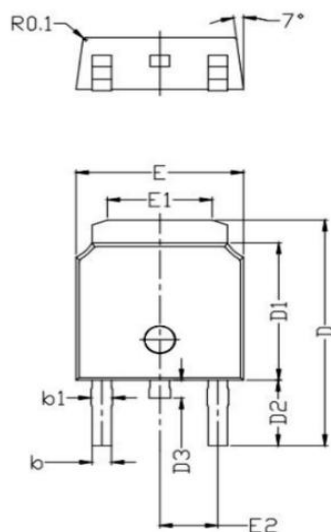


**Figure 3: Unclamped Inductive Switching Test Circuit & Waveform**



**Figure 4: Diode Recovery Test Circuit & Waveform**

### Package Mechanical Data(TO-252-3L)




PKG	COMMON DIMENSION (MM)		
	TO-252-3L		
Symbol	MIN	NOM	MAX
A	2.250	2.300	2.400
A1	0.010	0.060	0.150
A2	0.500	0.508	0.550
A3	0.960	1.010	1.060
b	0.740	0.760	0.800
b1	0.880	0.900	0.950
c	0.500	0.508	0.550
D	9.800	10.025	10.350
D1	6.050	6.100	6.180
D2	2.850	2.900	2.950
D3	0.700	0.800	2.900
E	6.550	6.600	6.700
E1	4.050	4.130	4.200
E2	2.250	2.286	2.300
L	1.400	1.500	1.600
e	7		
α	0°	2°	5°

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